

Product Description

The PE43601 is a HaRP™-enhanced, high linearity, 6-bit RF Digital Step Attenuator (DSA). This highly versatile DSA covers a 15.75 dB attenuation range in 0.25 dB steps. The Peregrine 50Ω RF DSA provides a serial-addressable CMOS control interface. It maintains high attenuation accuracy over frequency and temperature and exhibits very low insertion loss and low power consumption. Performance does not change with Vdd due to on-board regulator. This next generation Peregrine DSA is available in a 5x5 mm 32-lead QFN footprint.

The PE43601 is manufactured on Peregrine's UltraCMOS™ process, a patented variation of silicon-on-insulator (SOI) technology on a sapphire substrate, offering the performance of GaAs with the economy and integration of conventional CMOS.

Figure 1. Package Type

32-lead 5x5x0.85 mm QFN Package

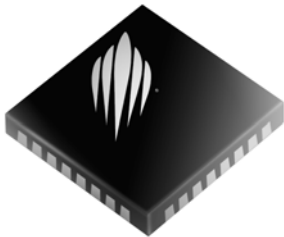
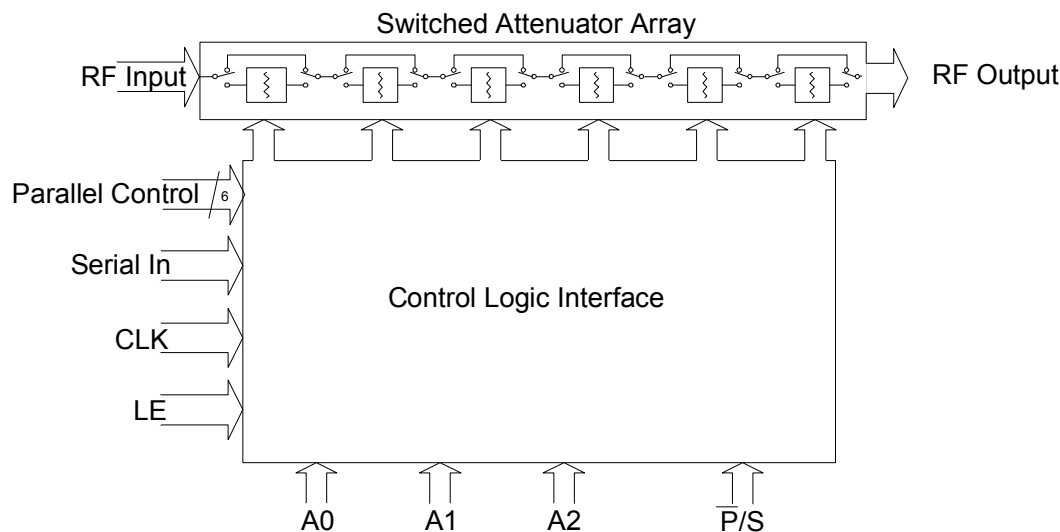


Figure 2. Functional Schematic Diagram



50 Ω RF Digital Attenuator
6-bit, 15.75 dB, DC-6.0 GHz

Features

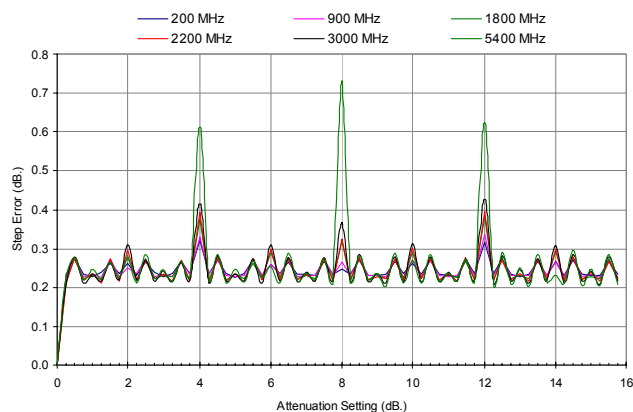
- HaRP™-enhanced UltraCMOS™ device
- Attenuation: 0.25 dB steps to 15.75 dB
- High Linearity: Typical +58 dBm IP3
 - Excellent low-frequency performance
- 3.3 V or 5.0 V Power Supply Voltage
- Fast switch settling time
- Programming Modes:
 - Direct Parallel
 - Latched Parallel
 - Serial-Addressable: Program up to eight addresses 000 - 111
 - Serial Two-Byte Protocol: Address and Data Word
- High-attenuation state @ power-up (PUP)
- CMOS Compatible
- No DC blocking capacitors required
- Packaged in a 32-lead 5x5x0.85 mm QFN

Table 1. Electrical Specifications @ +25°C, V_{DD} = 3.3 V or 5.0 V

| Parameter | Test Conditions | Frequency | Min | Typical | Max | Units |
|------------------------|---------------------------------------------------------------------------|----------------|-----|-----------|-------------|-------|
| Frequency Range | | | | DC – 6 | | GHz |
| Attenuation Range | 0.25 dB Step | | | 0 – 15.75 | | dB |
| Insertion Loss | | DC ≤ 6 GHz | | 2.3 | 2.8 | dB |
| Attenuation Error | 0 dB - 15.75 dB Attenuation settings | DC < 4 GHz | | | ±(0.2 + 4%) | dB |
| | 0 dB - 15.75 dB Attenuation settings | 4 GHz ≤ 6 GHz | | | ±(0.4 + 8%) | dB |
| Return Loss | | DC - 6 GHz | | 18 | | dB |
| Relative Phase | All States | DC - 6 GHz | | 20 | | deg |
| P1dB | Input | 20 MHz - 6 GHz | 30 | 32 | | dBm |
| IIP3 | Two tones at +18 dBm, 20 MHz spacing | 20 MHz - 6 GHz | | 57 | | dBm |
| Typical Spurious Value | | 1 MHz | | -110 | | dBm |
| Video Feed Through | | | | 10 | | mVpp |
| Switching Time | 50% CTRL to 10% / 90% RF | | | 650 | | ns |
| RF Trise/Tfall | 10% / 90% RF | | | 400 | | ns |
| Settling Time | RF settled to within 0.05 dB of final value RBW = 5 MHz, Averaging ON. | | | 4 | | µs |

Performance Plots

Figure 3. 0.25 dB Step Error vs. Frequency*



*Monotonicity is held so long as step-error does not cross zero.

Figure 4. 0.25dB Attenuation vs. Attenuation State

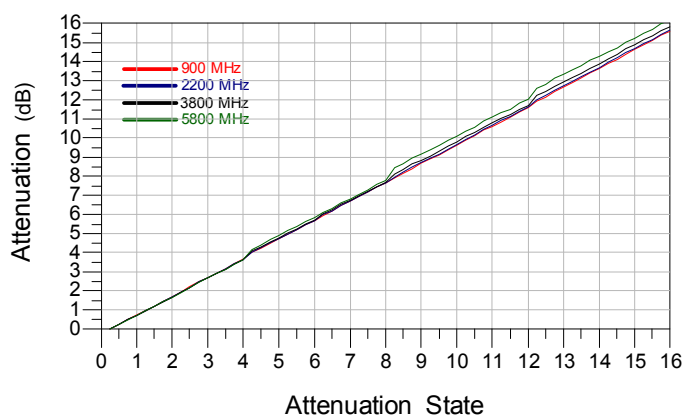


Figure 5. 0.25 dB Major State Bit Error

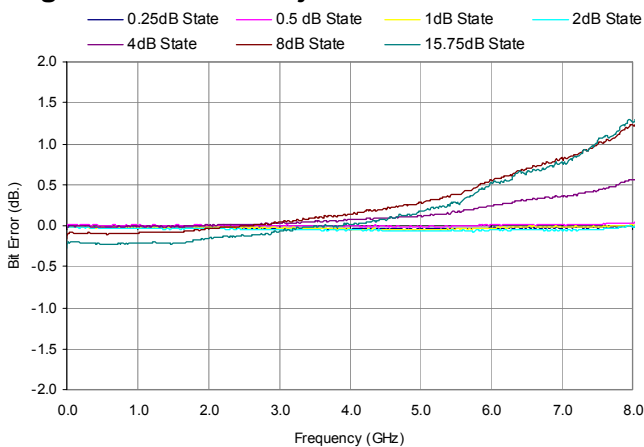


Figure 6. 0.25 dB Attenuation Error vs. Frequency

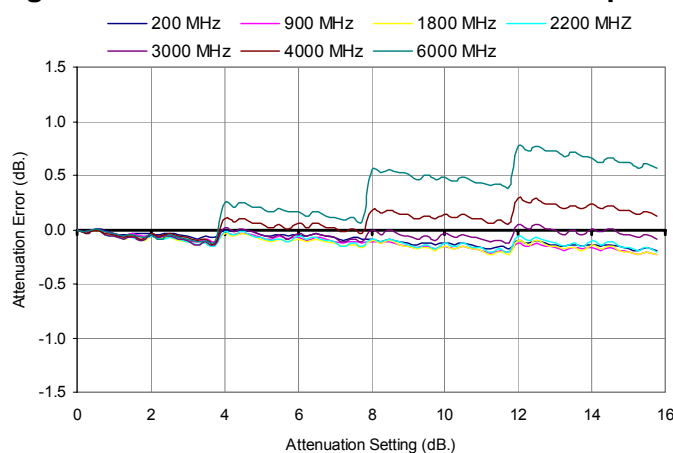
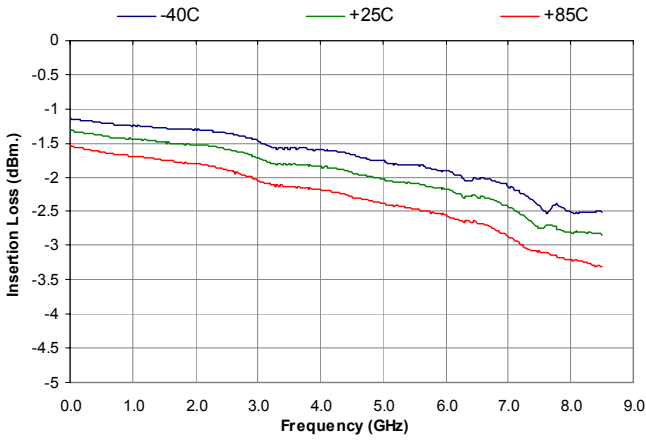
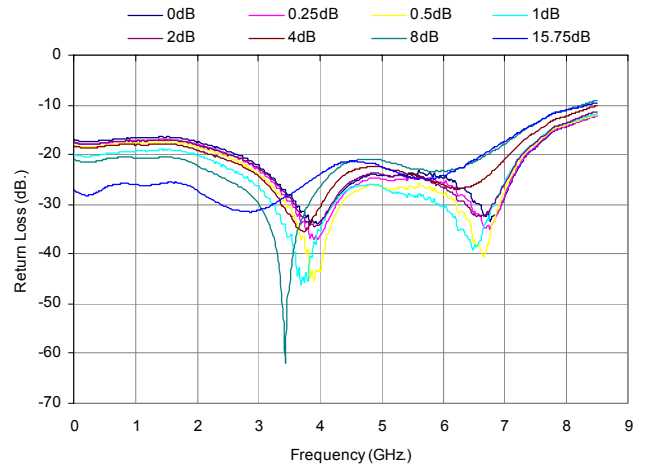


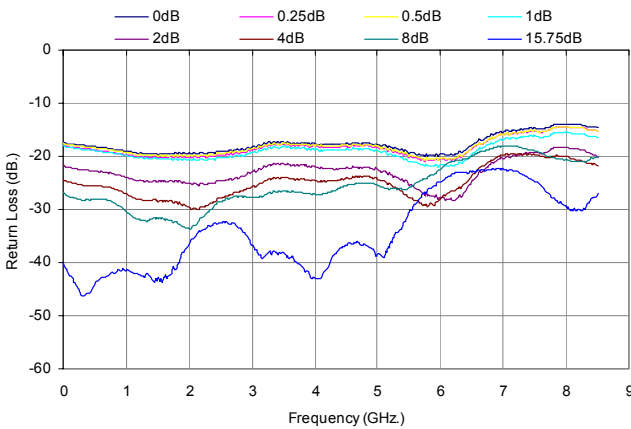
Figure 7. Insertion Loss vs. Temperature



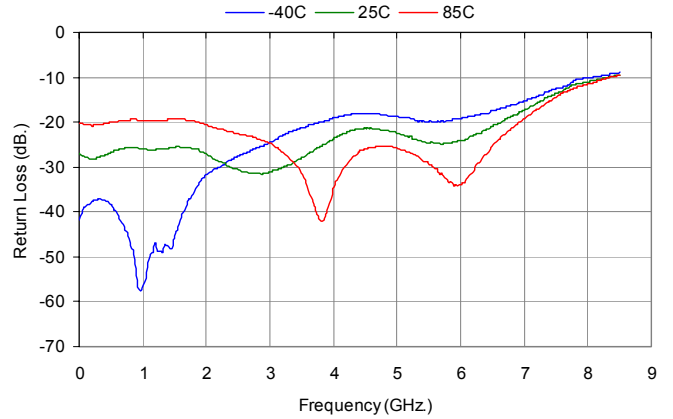
**Figure 8. Input Return Loss vs. Attenuation:
T = +25C**



**Figure 9. Output Return Loss vs. Attenuation:
T = +25C**



**Figure 10. Input Return Loss vs. Temperature:
15.75 dB State**



**Figure 11. Output Return Loss vs. Temperature:
15.75 dB State**

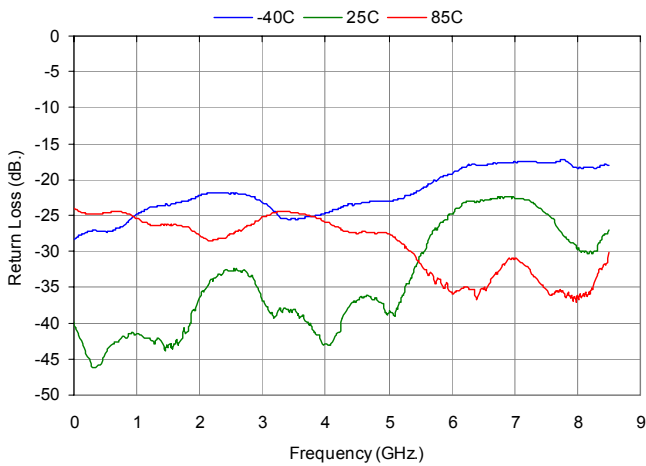
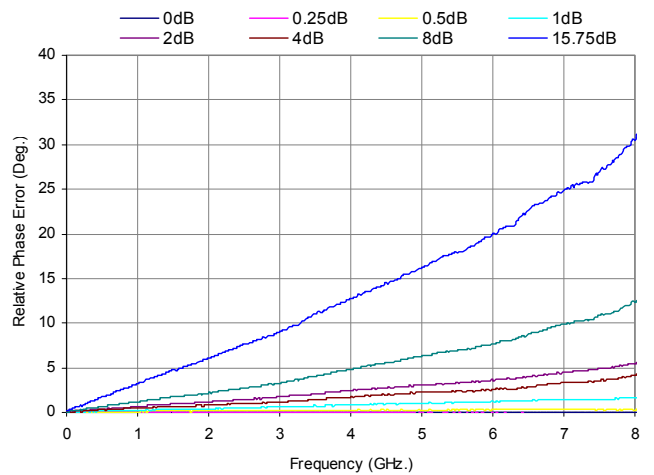
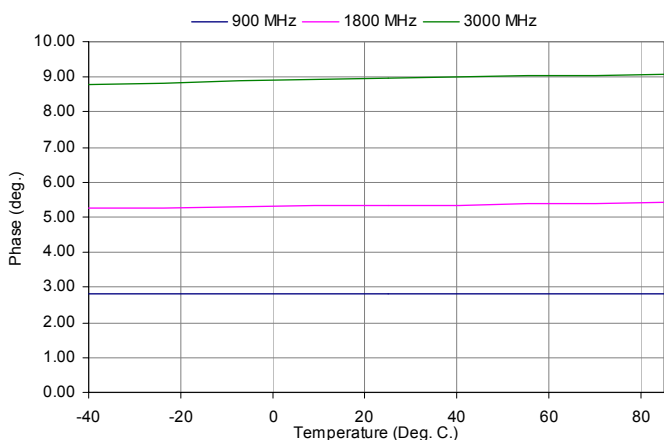


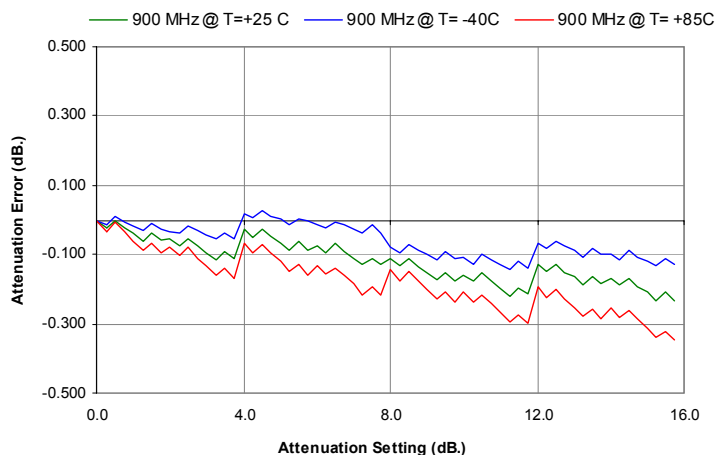
Figure 12. Relative Phase vs. Frequency



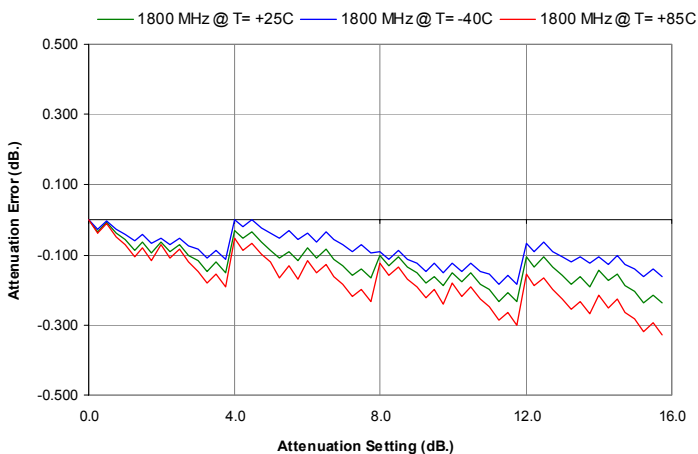
**Figure 13. Relative Phase vs. Temperature:
15.75 dB State**



**Figure 14. Attenuation Error vs. Attenuation
Setting: 900 MHz**



**Figure 15. Attenuation Error vs. Attenuation
Setting: 1800 MHz**



**Figure 16. Attenuation Error vs. Attenuation
Setting: 3000 MHz**

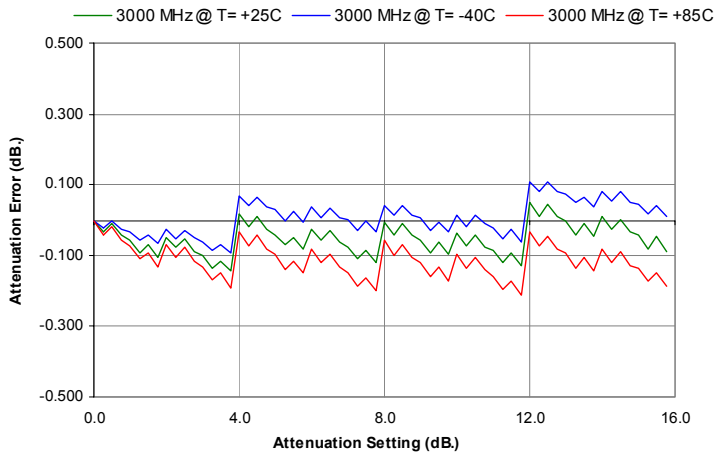


Figure 17. Input IP3 vs. Frequency

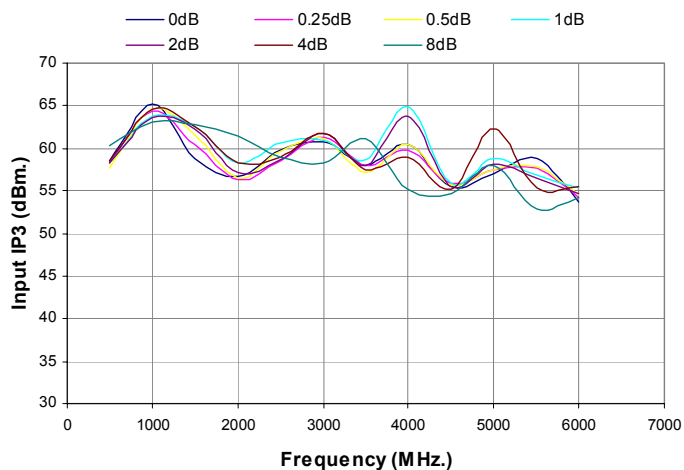


Figure 18. Pin Configuration (Top View)

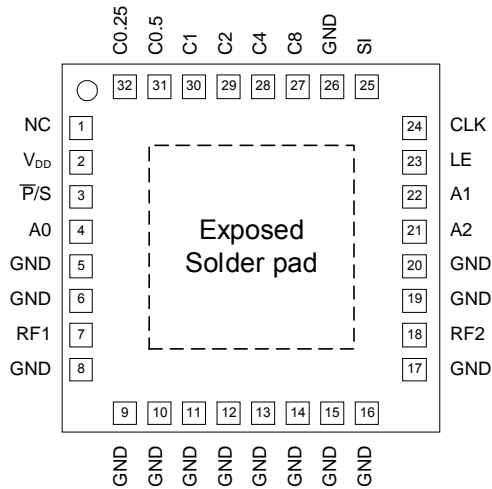


Table 2. Pin Descriptions

| Pin No. | Pin Name | Description |
|-----------------------------|-----------------|-----------------------------------------------|
| 1 | N/C | No Connect |
| 2 | V _{DD} | Power supply pin |
| 3 | P/S | Serial/Parallel mode select |
| 4 | A0 | A0 connection |
| 5, 6, 8 - 17, 19, 20, 26 | GND | Ground |
| 7 | RF1 | RF1 port |
| 18 | RF2 | RF2 port |
| 21 | A2 | A2 connection |
| 22 | A1 | A1 connection |
| 23 | LE | Latch Enable input |
| 24 | CLK | Serial interface clock input |
| 25 | SI | Serial Interface input |
| 27 | C8 | Attenuation control bit, 8 dB ¹ |
| 28 | C4 | Attenuation control bit, 4 dB ¹ |
| 29 | C2 | Attenuation control bit, 2 dB ¹ |
| 30 | C1 | Attenuation control bit, 1 dB ¹ |
| 31 | C0.5 | Attenuation control bit, 0.5 dB ¹ |
| 32 | C0.25 | Attenuation control bit, 0.25 dB ¹ |
| Paddle | GND | Ground for proper operation |

Note: 1. Ground C0.25, C0.5, C1, C2, C4, C8, C16 if not in use.

Electrostatic Discharge (ESD) Precautions

When handling this UltraCMOS™ device, observe the same precautions that you would use with other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the specified rating.

Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS™ devices are immune to latch-up.

Moisture Sensitivity Level

The Moisture Sensitivity Level rating for the PE43601 in the 32-lead 5x5 QFN package is MSL1.

Switching Frequency

The PE43601 has a maximum 25 kHz switching rate. Switching rate is defined to be the speed at which the DSA can be toggled across attenuation states.

Exposed Solder Pad Connection

The exposed solder pad on the bottom of the package must be grounded for proper device operation.

Table 3. Operating Ranges

| Parameter | Min | Typ | Max | Units |
|-----------------------------------------------------------------------|-----|-----|--------------------|------------|
| V _{DD} Power Supply Voltage | 3.0 | 3.3 | | V |
| V _{DD} Power Supply Voltage | | 5.0 | 5.5 | V |
| I _{DD} Power Supply Current | | 70 | 350 | μA |
| Digital Input High | 2.6 | | 5.5 | V |
| P _{IN} Input power (50Ω): 1 Hz ≤ 20 MHz 20 MHz ≤ 4 GHz | | | See fig. 19 +23 | dBm dBm |
| T _{OP} Operating temperature range | -40 | 25 | 85 | °C |
| Digital Input Low | 0 | | 1 | V |
| Digital Input Leakage ¹ | | | 15 | μA |

Note 1. Input leakage current per Control pin

Table 4. Absolute Maximum Ratings

| Symbol | Parameter/Conditions | Min | Max | Units |
|------------------|---------------------------------------------------------------|------|--------------------|------------|
| V _{DD} | Power supply voltage | -0.3 | 6.0 | V |
| V _I | Voltage on any Digital input | -0.3 | 5.8 | V |
| P _{IN} | Input power (50Ω) 1 Hz ≤ 20 MHz 20 MHz ≤ 4 GHz | | See fig. 19 +23 | dBm dBm |
| T _{ST} | Storage temperature range | -65 | 150 | °C |
| V _{ESD} | ESD voltage (HBM) ¹ ESD voltage (Machine Model) | | 500 100 | V V |

Note: 1. Human Body Model (HBM, MIL_STD 883 Method 3015.7)

Exceeding absolute maximum ratings may cause permanent damage. Operation should be restricted to the limits in the Operating Ranges table. Operation between operating range maximum and absolute maximum for extended periods may reduce reliability.

Figure 19. Maximum Power Handling Capability: Z₀ = 50 Ω

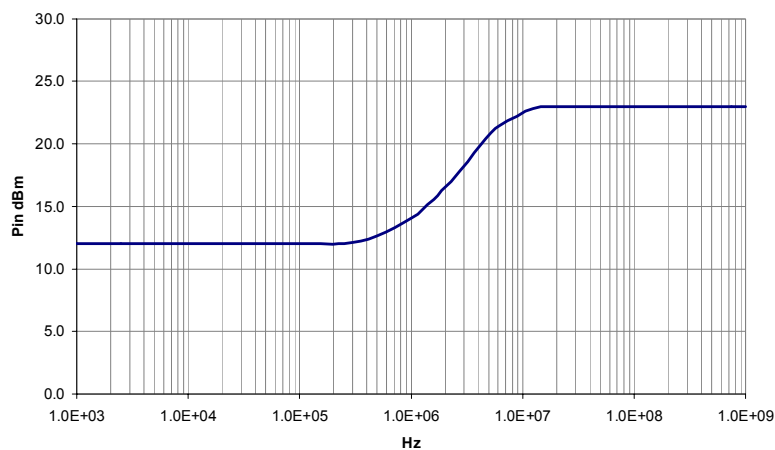


Table 5. Control Voltage

| State | Bias Condition |
|-------|------------------------------------|
| Low | 0 to +1.0 Vdc at 2 μ A (typ) |
| High | +2.6 to +5 Vdc at 10 μ A (typ) |

Table 6. Latch and Clock Specifications

| Latch Enable | Shift Clock | Function |
|--------------|-------------|-----------------------------------------------------------|
| X | \uparrow | Shift Register Clocked |
| \uparrow | X | Contents of shift register transferred to attenuator core |

Table 7. Parallel Truth Table

| Parallel Control Setting | | | | | | Attenuation Setting RF1-RF2 |
|--------------------------|----|----|----|----|----|--------------------------------|
| D5 | D4 | D3 | D2 | D1 | D0 | |
| L | L | L | L | L | L | Reference I.L. |
| L | L | L | L | L | H | 0.25 dB |
| L | L | L | L | H | L | 0.5 dB |
| L | L | L | H | L | L | 1 dB |
| L | L | H | L | L | L | 2 dB |
| L | H | L | L | L | L | 4 dB |
| H | L | L | L | L | L | 8 dB |
| H | H | H | H | H | H | 15.75 dB |

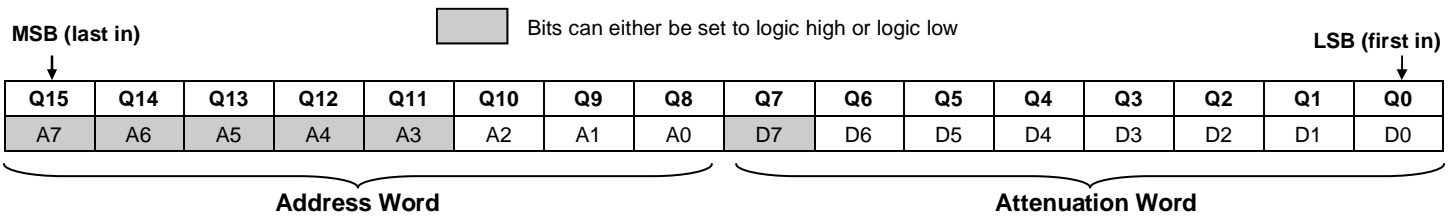
Table 8. Address Word Truth Table

| Address Word | | | | | | | | Address Setting |
|--------------|----|----|----|----|----|----|----|-----------------|
| A7 (MSB) | A6 | A5 | A4 | A3 | A2 | A1 | A0 | |
| X | X | X | X | X | L | L | L | 000 |
| X | X | X | X | X | L | L | H | 001 |
| X | X | X | X | X | L | H | L | 010 |
| X | X | X | X | X | L | H | H | 011 |
| X | X | X | X | X | H | L | L | 100 |
| X | X | X | X | X | H | L | H | 101 |
| X | X | X | X | X | H | H | L | 110 |
| X | X | X | X | X | H | H | H | 111 |

Table 9. Serial Attenuation Word Truth Table

| Attenuation Word | | | | | | | | Attenuation Setting RF1-RF2 |
|------------------|----|----|----|----|----|----|----------|--------------------------------|
| D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 (LSB) | |
| X | L | L | L | L | L | L | L | Reference I.L. |
| X | L | L | L | L | L | L | H | 0.25 dB |
| X | L | L | L | L | L | H | L | 0.5 dB |
| X | L | L | L | L | H | L | L | 1 dB |
| X | L | L | L | H | L | L | L | 2 dB |
| X | L | L | H | L | L | L | L | 4 dB |
| X | L | H | L | L | L | L | L | 8 dB |
| X | L | H | H | H | H | H | H | 15.75 dB |

Table 10. Serial-Addressable Register Map



Attenuation Word is derived directly from the attenuation value. For example, to program the 12.75 dB state at address 3:

Address Word: XXXXX011
 Attenuation Word: Multiply by 4 and convert to binary $\rightarrow 4 * 12.75 \text{ dB} \rightarrow 51 \rightarrow 0110011$
 Serial Input: XXXXX011X0110011

Programming Options

Parallel/Serial Selection

Either a parallel or serial interface can be used to control the PE43601. The \bar{P}/S bit provides this selection, with $\bar{P}/S=LOW$ selecting the parallel interface and $\bar{P}/S=HIGH$ selecting the serial interface.

Parallel Mode Interface

The parallel interface consists of six CMOS-compatible control lines that select the desired attenuation state, as shown in *Table 7*.

The parallel interface timing requirements are defined by *Fig. 21* (Parallel Interface Timing Diagram), *Table 12* (Parallel Interface AC Characteristics), and switching speed (*Table 1*).

For *latched*-parallel programming the Latch Enable (LE) should be held LOW while changing attenuation state control values, then pulse LE HIGH to LOW (*per Fig. 21*) to latch new attenuation state into device.

For *direct* parallel programming, the Latch Enable (LE) line should be pulled HIGH. Changing attenuation state control values will change device state to new attenuation. Direct Mode is ideal for manual control of the device (using hardware, switches, or jumpers).

Serial-Addressable Interface

The serial interface is a 16-bit serial-in, parallel-out shift register buffered by a transparent latch. The 16-bits make up two words comprised of 8-bits each. The first word is the Attenuation Word, which controls the state of the DSA. The second word is the Address Word, which is compared to the static (or programmed) logical states of the A0, A1 and A2 digital inputs. If there is an address match, the DSA changes state; otherwise its current state will remain unchanged. *Fig. 20* illustrates a example timing diagram for programming a state. It is recommended that all parallel control inputs be grounded when the DSA is used in serial mode.

The serial-addressable interface is controlled using three CMOS-compatible signals: Serial-In (SI), Clock (CLK), and Latch Enable (LE). The SI and CLK inputs allow data to be serially entered into the shift register. Serial data is clocked in LSB first, beginning with the attenuation word.

The shift register must be loaded while LE is held LOW to prevent the attenuator value from changing as data is entered. The LE input should then be toggled HIGH and brought LOW again, latching the new data into the DSA. Address word and attenuation word truth tables are listed in *Table 8* & *Table 9*, respectively. A programming example of the Serial-Addressable register is illustrated in *Table 10*. The serial-addressable timing diagram is illustrated in *Fig. 20*.

Power-up Control Settings

The PE43601 will always initialize to the maximum attenuation setting (15.75 dB) on power-up for both the serial-addressable and latched-parallel modes of operation and will remain in this setting until the user latches in the next programming word. In direct-parallel mode, the DSA can be preset to any state within the 15.75 dB range by pre-setting the parallel control pins prior to power-up. In this mode, there is a 400- μ s delay between the time the DSA is powered-up to the time the desired state is set. During this power-up delay, the device attenuates to the maximum attenuation setting (15.75 dB) before defaulting to the user defined state. If the control pins are left floating in this mode during power-up, the device will default to the minimum attenuation setting (insertion loss state).

Figure 20. Serial-Addressable Timing Diagram

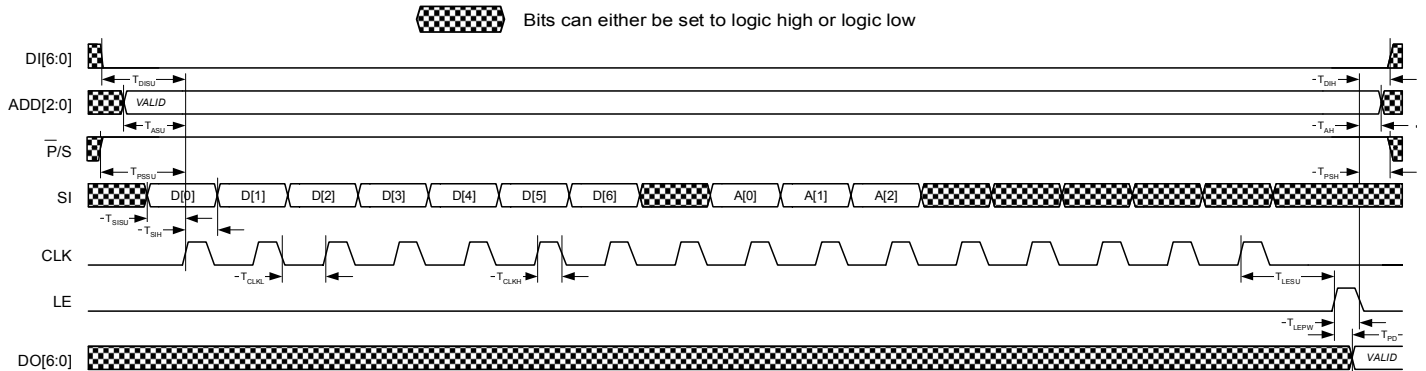


Figure 21. Latched-Parallel/Direct-Parallel Timing Diagram

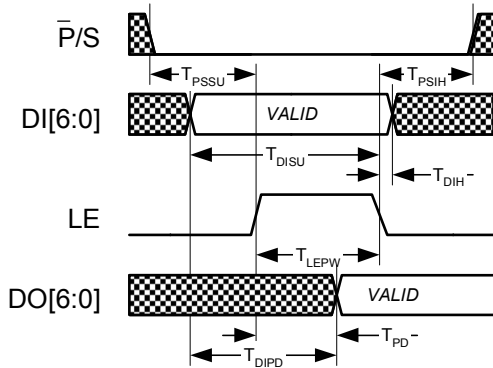


Table 11. Serial Interface AC Characteristics

$V_{DD} = 3.3$ or 5.0 V, $-40^{\circ}C < T_A < 85^{\circ}C$, unless otherwise specified

| Symbol | Parameter | Min | Max | Unit |
|------------|----------------------------------------------------------------------|-----|-----|------|
| F_{CLK} | Serial clock frequency | - | 10 | MHz |
| T_{CLKH} | Serial clock HIGH time | 30 | - | ns |
| T_{CLKL} | Serial clock LOW time | 30 | - | ns |
| T_{LESU} | Last serial clock rising edge setup time to Latch Enable rising edge | 10 | - | ns |
| T_{LEPW} | Latch Enable min. pulse width | 30 | - | ns |
| T_{SISU} | Serial data setup time | 10 | - | ns |
| T_{SIH} | Serial data hold time | 10 | - | ns |
| T_{DISU} | Parallel data setup time | 100 | - | ns |
| T_{DIH} | Parallel data hold time | 100 | - | ns |
| T_{ASU} | Address setup time | 100 | - | ns |
| T_{AH} | Address hold time | 100 | - | ns |
| T_{PSSU} | Parallel/Serial setup time | 100 | - | ns |
| T_{PSH} | Parallel/Serial hold time | 100 | - | ns |
| T_{PD} | Digital register delay (internal) | - | 10 | ns |

Note: f_{CLK} is verified during the functional pattern test. Serial programming sections of the functional pattern are clocked at 10 MHz to verify f_{CLK} specification.

Table 12. Parallel and Direct Interface AC Characteristics

$V_{DD} = 3.3$ or 5.0 V, $-40^{\circ}C < T_A < 85^{\circ}C$, unless otherwise specified

| Symbol | Parameter | Min | Max | Unit |
|------------|-----------------------------------------------------|-----|-----|------|
| T_{LEPW} | Latch Enable minimum pulse width | 30 | - | ns |
| T_{DISU} | Parallel data setup time | 100 | - | ns |
| T_{DIH} | Parallel data hold time | 100 | - | ns |
| T_{PSSU} | Parallel/Serial setup time | 100 | - | ns |
| T_{PSIH} | Parallel/Serial hold time | 100 | - | ns |
| T_{PD} | Digital register delay (internal) | - | 10 | ns |
| T_{DIPD} | Digital register delay (internal, direct mode only) | - | 5 | ns |

Evaluation Kit

The Digital Attenuator Evaluation Kit board was designed to ease customer evaluation of the PE43601 Digital Step Attenuator.

Direct-Parallel Programming Procedure

For automated direct-parallel programming, connect the test harness provided with the EVK from the parallel port of the PC to the J1 & Serial header pin and set the D0-D5 SP3T switches to the 'MIDDLE' toggle position. Position the Parallel/Serial (P/S) select switch to the Parallel (or left) position. The evaluation software is written to operate the DSA in either Parallel or Serial-Addressable Mode. Ensure that the software is set to program in *Direct-Parallel* mode. Using the software, enable or disable each setting to the desired attenuation state. The software automatically programs the DSA each time an attenuation state is enabled or disabled.

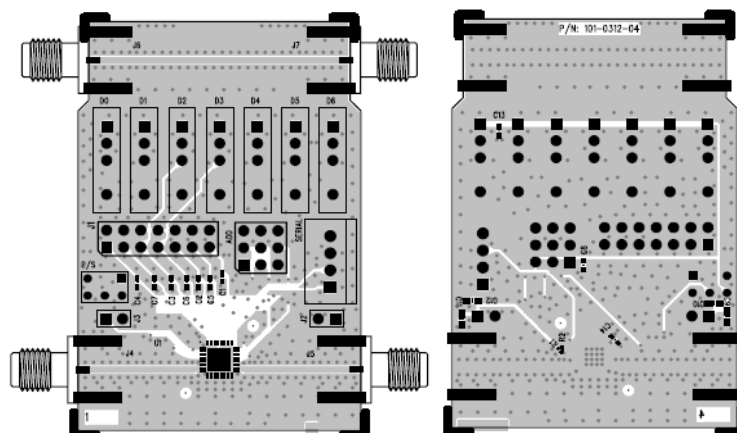
For manual direct-parallel programming, disconnect the test harness provided with the EVK from the J1 and Serial header pins. Position the Parallel/Serial (P/S) select switch to the Parallel (or left) position. The LE pin on the Serial header must be tied to logic high. Switches D0-D5 are SP3T switches which enable the user to manually program the parallel bits. When any input D0-D5 is toggled 'UP', logic high is presented to the parallel input. When toggled 'DOWN', logic low is presented to the parallel input. Setting D0-D5 to the 'MIDDLE' toggle position presents an OPEN, which forces an on-chip logic low. Table 7 depicts the parallel programming truth table and Fig. 21 illustrates the parallel programming timing diagram.

Latched-Parallel Programming Procedure

For automated latched-parallel programming, the procedure is identical to the direct-parallel method. The user only must ensure that *Latched-Parallel* is selected in the software.

Figure 22. Evaluation Board Layout

Peregrine Specification 101-0312



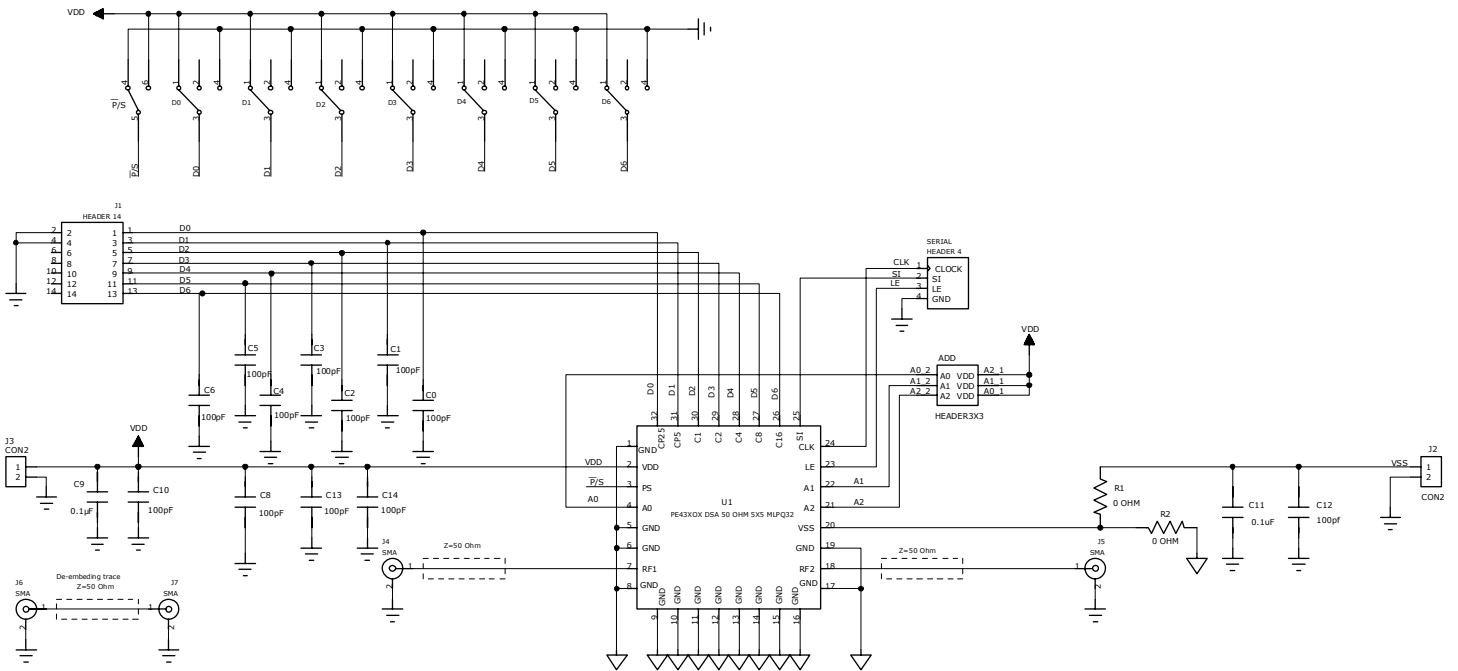
Note: Reference Fig. 23 for Evaluation Board Schematic

For manual latched-parallel programming, the procedure is identical to direct-parallel except now the LE pin on the Serial header must be logic low as the parallel bits are applied. The user must then pulse LE from 0V to V_{DD} and back to 0V to latch the programming word into the DSA. LE must be logic low prior to programming the next word.

Serial-Addressable Programming Procedure

Position the Parallel/Serial (P/S) select switch to the Serial (or right) position. Prior to programming, the user must define an address setting using the ADD header pin. Jump the middle pins on the ADD header A0-A2 (or lower) row of pins to set logic high, or jump the middle pins to the upper row of pins to set logic low. If the ADD pins are left open, then 000 become the default address. The evaluation software is written to operate the DSA in either Parallel or Serial-Addressable Mode. Ensure that the software is set to program in *Serial-Addressable* mode. Using the software, enable or disable each setting to the desired attenuation state. The software automatically programs the DSA each time an attenuation state is enabled or disabled.

Figure 23. Evaluation Board Schematic
Peregrine Specification 102-0381



Note: Pin 26 is grounded.

Figure 24. Package Drawing

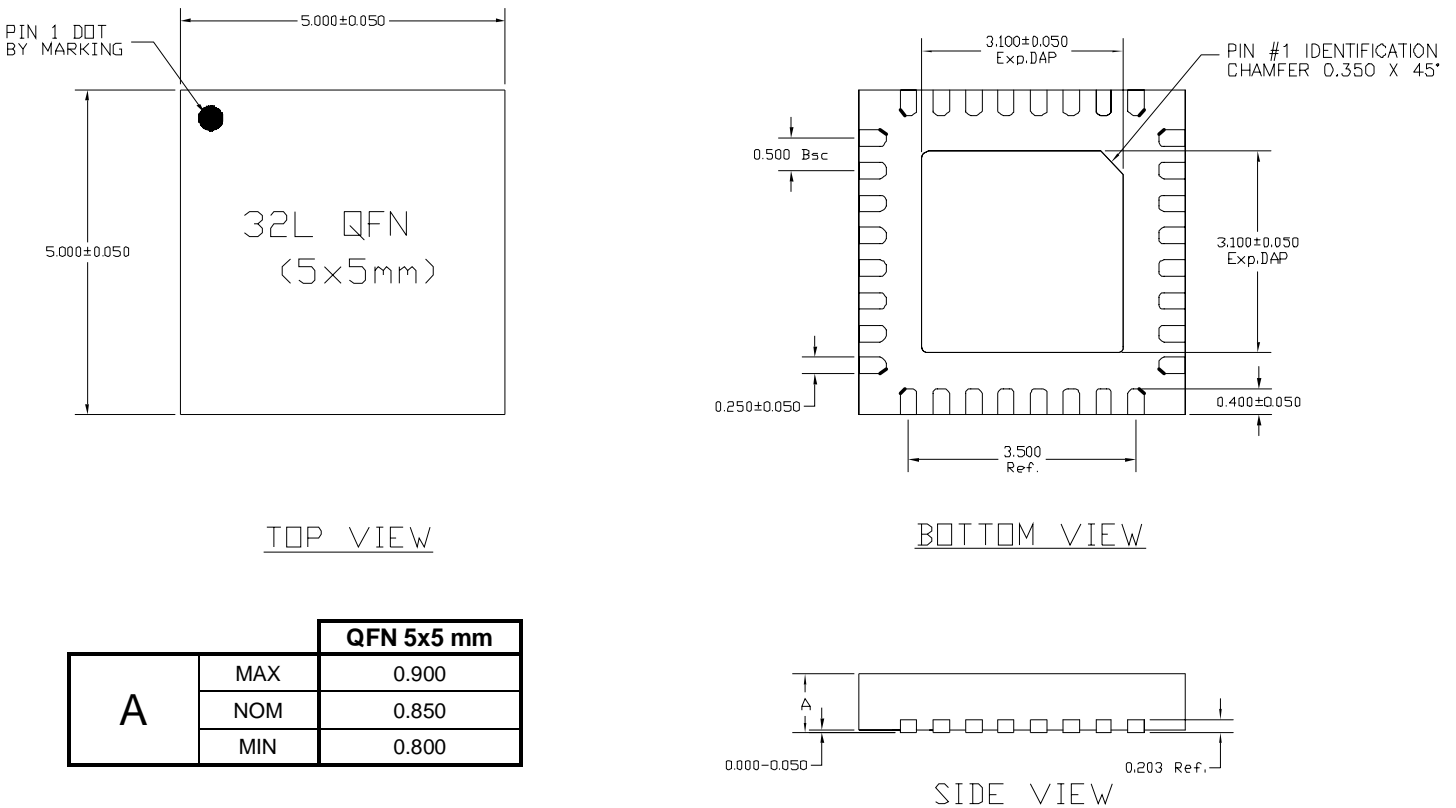
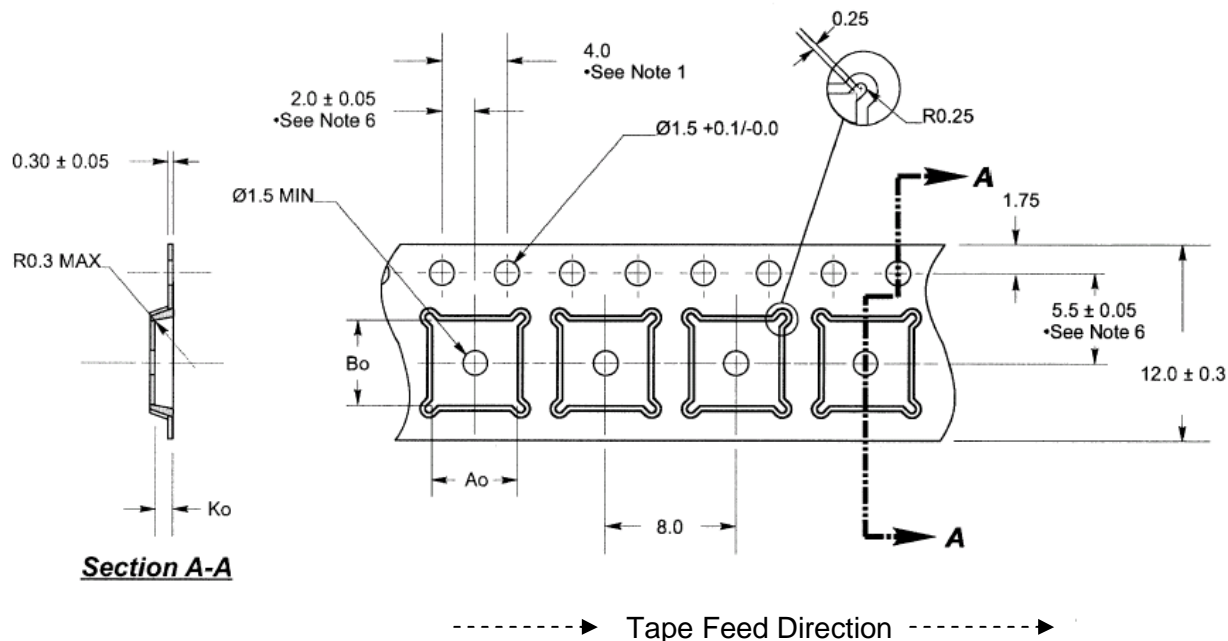


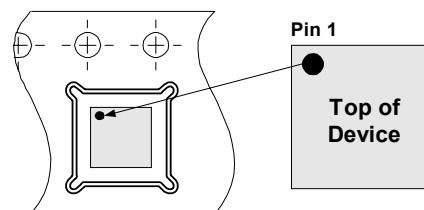
Figure 25. Tape and Reel Drawing



Notes:

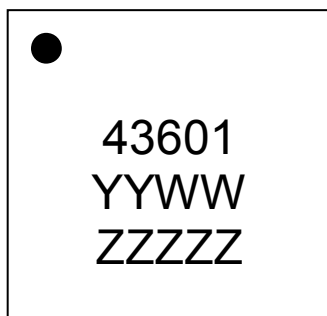
1. 10 sprocket hole pitch cumulative tolerance ± 0.2 .
2. Camber not to exceed 1mm in 100mm.
3. Material: PS + C.
4. Ao and Bo measured as indicated.
5. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
6. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.

Ao = 5.25 mm
Bo = 5.25 mm
Ko = 1.1 mm



Device Orientation in Tape

Figure 26. Marking Specifications



YYWW = Date Code
ZZZZZ = Last five digits of Lot Number

Table 13. Ordering Information

| Order Code | Part Marking | Description | Package | Shipping Method |
|--------------|--------------|-------------------------------|-------------------------|----------------------------|
| PE43601MLI | 43601 | PE43601 G - 32QFN 5x5mm-75A | Green 32-lead 5x5mm QFN | Bulk or tape cut from reel |
| PE43601MLI-Z | 43601 | PE43601 G - 32QFN 5x5mm-3000C | Green 32-lead 5x5mm QFN | 3000 units / T&R |
| EK43601-01 | 43601 | PE43601 - 32QFN 5x5mm-EK | Evaluation Kit | 1 / Box |

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